

SILICON POWER TRANSISTORS 2SC4331, 2SC4331-Z

NPN SILICON EPITAXIAL TRANSISTOR FOR HIGH-SPEED SWITCHING

The 2SC4331 and 2SC4331-Z are mold power transistors developed for high-speed switching and features a very low collector-to-emitter saturation voltage.

This transistor is ideal for use in switching regulators, DC/DC converters, motor drivers, solenoid drivers, and other low-voltage power supply devices, as well as for high-current switching.

FEATURES

- Available for high-current control in small dimension
- Z type is a lead-processed product and is deal for mounting a hybrid IC.
- Low collector saturation voltage
 $V_{CE(sat)} = 0.3 \text{ V MAX. (@ } I_c = 3 \text{ A)}$
- Fast switching speed:
 $t_f \leq 0.4 \mu\text{s MAX. (@ } I_c = 3 \text{ A)}$
- High DC current gain and excellent linearity

ABSOLUTE MAXIMUM RATINGS ($T_A = 25^\circ\text{C}$)

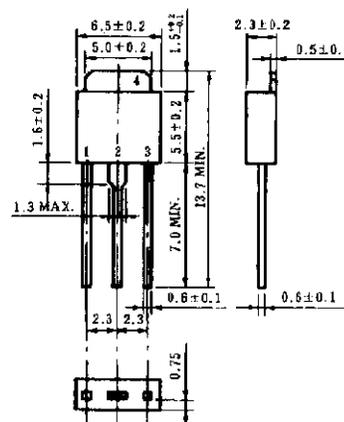
| Parameter | Symbol | Ratings | Unit |
|------------------------------|--------------------------------|---------------|------------------|
| Collector to base voltage | V_{CBO} | 150 | V |
| Collector to emitter voltage | V_{CEO} | 100 | V |
| Base to emitter voltage | V_{EBO} | 7.0 | V |
| Collector current (DC) | $I_{C(DC)}$ | 5.0 | A |
| Collector current (pulse) | $I_{C(pulse)^*}$ | 10 | A |
| Base current (DC) | $I_{B(DC)}$ | 2.5 | A |
| Total power dissipation | $P_T (T_C = 25^\circ\text{C})$ | 15 | W |
| Total power dissipation | $P_T (T_A = 25^\circ\text{C})$ | 1.0**, 2.0*** | W |
| Junction temperature | T_j | 150 | $^\circ\text{C}$ |
| Storage temperature | T_{stg} | -55 to +150 | $^\circ\text{C}$ |

* $PW \leq 10 \text{ ms}$, duty cycle $\leq 50\%$

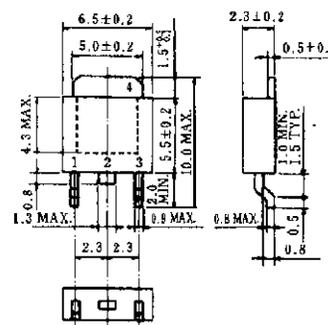
** Printing board mounted

*** $7.5 \text{ mm}^2 \times 0.7 \text{ mm}$, ceramic board mounted

PACKAGE DRAWING (UNIT: mm)



MP-3



MP-3Z

Electrode Connection

1. Base
2. Collector
3. Emitter
4. Fin (collector)

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ELECTRICAL CHARACTERISTICS (T_A = 25°C)

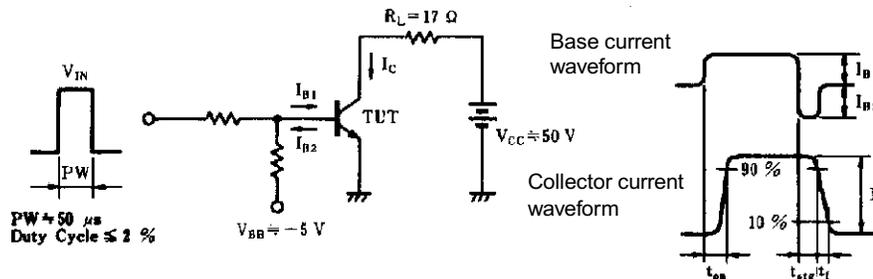
| Parameter | Symbol | Conditions | MIN. | TYP. | MAX. | Unit |
|------------------------------|-------------------------|--|------|------|------|------|
| Collector to emitter voltage | V _{CEO(SUS)} | I _C = 2.5 A, I _B = 0.25 A, L = 1 mH | 100 | | | V |
| Collector to emitter voltage | V _{CEx(SUS)} | I _C = 2.5 A, I _{B1} = -I _{B2} = 0.25 A, V _{BE(OFF)} = -1.5 V, L = 180 μH, clamped | 100 | | | V |
| Collector cutoff current | I _{CBO} | V _{CE} = 100 V, I _E = 0 | | | 10 | μA |
| Collector cutoff current | I _{CER} | V _{CE} = 100 V, R _{BE} = 50 Ω, T _A = 125°C | | | 1.0 | mA |
| Collector cutoff current | I _{CEx1} | V _{CE} = 100 V, V _{BE(OFF)} = -1.5 V | | | 10 | μA |
| Collector cutoff current | I _{CEx2} | V _{CE} = 100 V, V _{BE(OFF)} = -1.5 V, T _A = 125°C | | | 1.0 | mA |
| Emitter cutoff current | I _{EBO} | V _{EB} = 5.0 V, I _C = 0 | | | 10 | μA |
| DC current gain | h _{FE1} * | V _{CE} = 2.0 V, I _C = 0.5 A | 100 | | | |
| DC current gain | h _{FE2} * | V _{CE} = 2.0 V, I _C = 1.0 A | 100 | 200 | 400 | |
| DC current gain | h _{FE3} * | V _{CE} = 2.0 V, I _C = 3.0 A | 60 | | | |
| Collector saturation voltage | V _{CE(sat)1} * | I _C = 3.0 A, I _B = 0.15 A | | | 0.3 | V |
| Collector saturation voltage | V _{CE(sat)2} * | I _C = 4.0 A, I _B = 0.2 A | | | 0.5 | V |
| Base saturation voltage | V _{BE(sat)1} * | I _C = 3.0 A, I _B = 0.15 A | | | 1.2 | V |
| Base saturation voltage | V _{BE(sat)2} * | I _C = 4.0 A, I _B = 0.2 A | | | 1.5 | V |
| Collector capacitance | C _{ob} | V _{CB} = 10 V, I _E = 0, f = 1.0 MHz | | 60 | | pF |
| Gain bandwidth product | f _T | V _{CE} = 10 V, I _E = -0.5 A | | 150 | | MHz |
| Turn-on time | t _{on} | I _C = 3.0 A, R _L = 17 Ω, I _{B1} = -I _{B2} = 0.15 A, V _{CC} ≅ 50 V Refer to the test circuit. | | | 0.3 | μs |
| Storage time | t _{stg} | | | | 1.5 | μs |
| Fall time | t _f | | | | 0.4 | μs |

* Pulse test PW ≤ 350 μs, duty cycle ≤ 2%

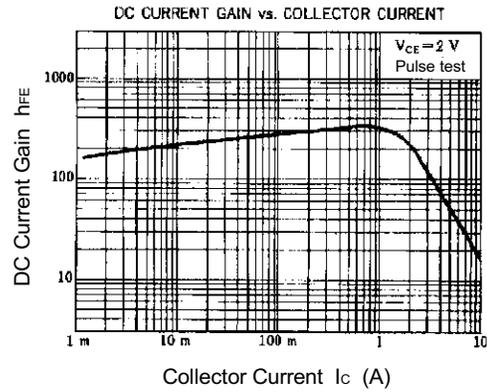
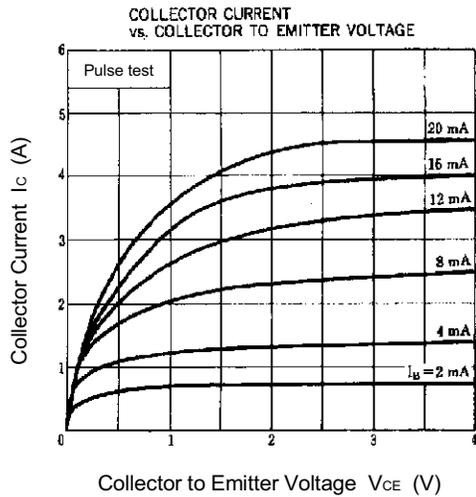
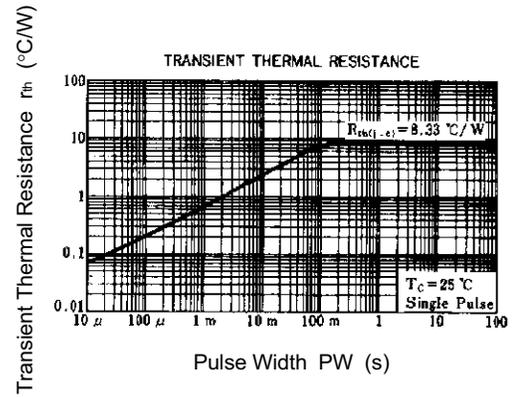
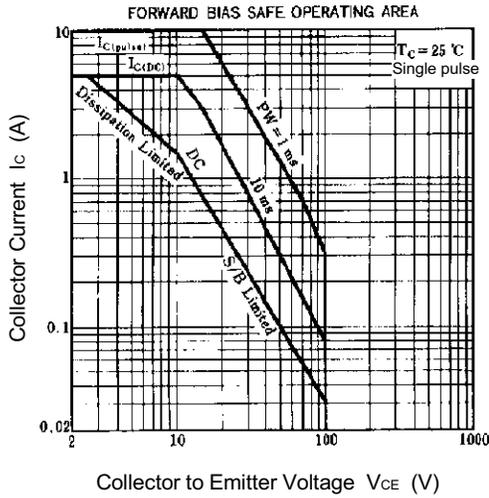
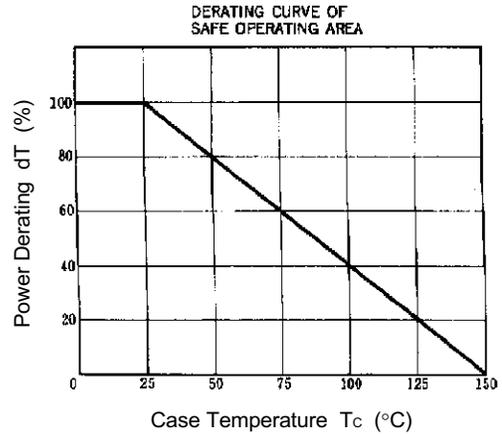
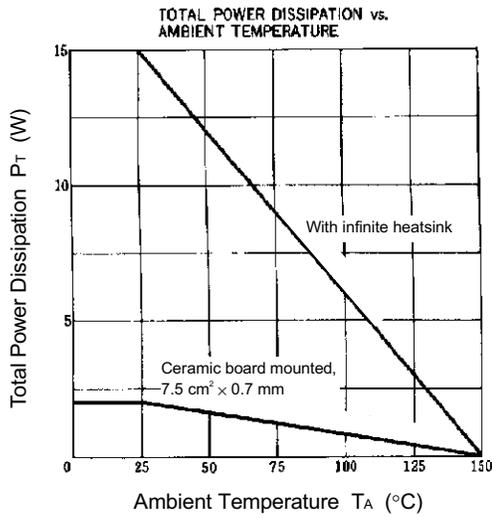
h_{FE} CLASSIFICATION

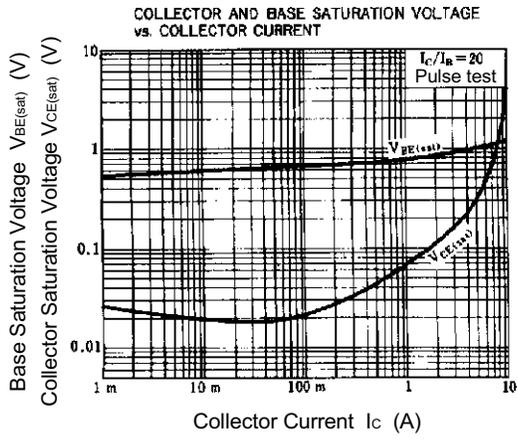
| Marking | M | L | K |
|------------------|------------|------------|------------|
| h _{FE2} | 100 to 200 | 150 to 300 | 200 to 400 |

SWITCHING TIME (t_{on}, t_{stg}, t_f) TEST CIRCUIT



TYPICAL CHARACTERISTICS (T_A = 25°C)





[MEMO]

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